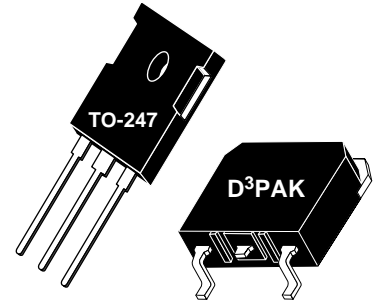
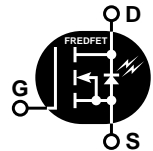


POWER MOS V®
FREDFET


Power MOS V® is a new generation of high voltage N-Channel enhancement mode power MOSFETs. This new technology minimizes the JFET effect, increases packing density and reduces the on-resistance. Power MOS V® also achieves faster switching speeds through optimized gate layout.

- Fast Recovery Body Diode
- 100% Avalanche Tested
- Lower Leakage
- Faster Switching
- TO-247 or Surface Mount D³PAK Package


MAXIMUM RATINGS

 All Ratings: $T_C = 25^\circ\text{C}$ unless otherwise specified.

| Symbol | Parameter | APT5017BVFR_SVFR | UNIT |
|----------------|--|------------------|---------------------|
| V_{DSS} | Drain-Source Voltage | 500 | Volts |
| I_D | Continuous Drain Current @ $T_C = 25^\circ\text{C}$ | 30 | Amps |
| I_{DM} | Pulsed Drain Current ^① | 120 | |
| V_{GS} | Gate-Source Voltage Continuous | ± 30 | Volts |
| V_{GSM} | Gate-Source Voltage Transient | ± 40 | |
| P_D | Total Power Dissipation @ $T_C = 25^\circ\text{C}$ | 370 | Watts |
| | Linear Derating Factor | 2.96 | W/ $^\circ\text{C}$ |
| T_J, T_{STG} | Operating and Storage Junction Temperature Range | -55 to 150 | $^\circ\text{C}$ |
| T_L | Lead Temperature: 0.063" from Case for 10 Sec. | 300 | |
| I_{AR} | Avalanche Current ^① (Repetitive and Non-Repetitive) | 30 | Amps |
| E_{AR} | Repetitive Avalanche Energy ^① | 30 | mJ |
| E_{AS} | Single Pulse Avalanche Energy ^④ | 1300 | |

STATIC ELECTRICAL CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | MIN | TYP | MAX | UNIT |
|--------------|--|-----|-----|-----------|---------------|
| BV_{DSS} | Drain-Source Breakdown Voltage ($V_{GS} = 0V, I_D = 250\mu\text{A}$) | 500 | | | Volts |
| $I_{D(on)}$ | On State Drain Current ^② ($V_{DS} > I_{D(on)} \times R_{DS(on)}$ Max, $V_{GS} = 10V$) | 30 | | | Amps |
| $R_{DS(on)}$ | Drain-Source On-State Resistance ^② ($V_{GS} = 10V, 0.5 I_{D[Cont.]}$) | | | 0.17 | Ohms |
| I_{DSS} | Zero Gate Voltage Drain Current ($V_{DS} = V_{DSS}, V_{GS} = 0V$) | | | 250 | μA |
| | Zero Gate Voltage Drain Current ($V_{DS} = 0.8 V_{DSS}, V_{GS} = 0V, T_C = 125^\circ\text{C}$) | | | 1000 | |
| I_{GSS} | Gate-Source Leakage Current ($V_{GS} = \pm 30V, V_{DS} = 0V$) | | | ± 100 | nA |
| $V_{GS(th)}$ | Gate Threshold Voltage ($V_{DS} = V_{GS}, I_D = 1.0\text{mA}$) | 2 | | 4 | Volts |

 **CAUTION:** These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

APT Website - <http://www.advancedpower.com>

DYNAMIC CHARACTERISTICS

APT5017BVFR_SVFR

| Symbol | Characteristic | Test Conditions | MIN | TYP | MAX | UNIT |
|---------------------|--------------------------------|--|-----|------|------|------|
| C _{iss} | Input Capacitance | V _{GS} = 0V | | 4400 | 5280 | pF |
| C _{oss} | Output Capacitance | V _{DS} = 25V | | 600 | 840 | |
| C _{rss} | Reverse Transfer Capacitance | f = 1 MHz | | 230 | 350 | |
| Q _g | Total Gate Charge ^③ | V _{GS} = 10V | | 200 | 300 | nC |
| Q _{gs} | Gate-Source Charge | V _{DD} = 0.5 V _{DSS} | | 30 | 45 | |
| Q _{gd} | Gate-Drain ("Miller") Charge | I _D = I _D [Cont.] @ 25°C | | 80 | 120 | |
| t _{d(on)} | Turn-on Delay Time | V _{GS} = 15V | | 12 | 25 | ns |
| t _r | Rise Time | V _{DD} = 0.5 V _{DSS} | | 14 | 30 | |
| t _{d(off)} | Turn-off Delay Time | I _D = I _D [Cont.] @ 25°C | | 55 | 80 | |
| t _f | Fall Time | V _G = 1.6Ω | | 11 | 20 | |

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

| Symbol | Characteristic / Test Conditions | MIN | TYP | MAX | UNIT |
|------------------|---|------------------------|-----|-----|-------|
| I _S | Continuous Source Current (Body Diode) | | | 30 | Amps |
| I _{SM} | Pulsed Source Current ^① (Body Diode) | | | 120 | |
| V _{SD} | Diode Forward Voltage ^② (V _{GS} = 0V, I _S = -I _D [Cont.]) | | | 1.3 | Volts |
| dv/dt | Peak Diode Recovery ^{dv/dt} ^⑤ | | | 5 | V/ns |
| t _{rr} | Reverse Recovery Time (I _S = -I _D [Cont.], di/dt = 100A/μs) | T _j = 25°C | | 250 | ns |
| | | T _j = 125°C | | 525 | |
| Q _{rr} | Reverse Recovery Charge (I _S = -I _D [Cont.], di/dt = 100A/μs) | T _j = 25°C | | 1.6 | μC |
| | | T _j = 125°C | | 6.0 | |
| I _{RRM} | Peak Recovery Current (I _S = -I _D [Cont.], di/dt = 100A/μs) | T _j = 25°C | | 13 | Amps |
| | | T _j = 125°C | | 21 | |

THERMAL CHARACTERISTICS

| Symbol | Characteristic | MIN | TYP | MAX | UNIT |
|------------------|---------------------|-----|-----|------|------|
| R _{θJC} | Junction to Case | | | 0.34 | °C/W |
| R _{θJA} | Junction to Ambient | | | 40 | |

① Repetitive Rating: Pulse width limited by maximum junction temperature.

② Pulse Test: Pulse width < 380 μs, Duty Cycle < 2%

③ See MIL-STD-750 Method 3471

④ Starting T_j = +25°C, L = 2.89mH, R_G = 25Ω, Peak I_L = 30A

⑤ I_S ≤ -I_D [Cont.], di/dt = 100A/μs, V_{DD} ≤ V_{DSS}, T_j ≤ 150°C, R_G = 2.0Ω, V_R = 200V.

APT Reserves the right to change, without notice, the specifications and information contained herein.

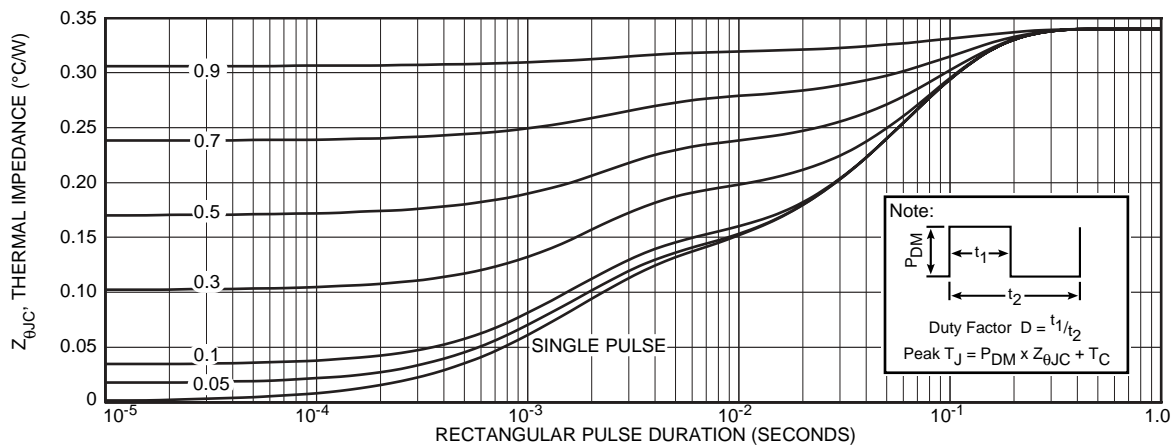


FIGURE 1, MAXIMUM EFFECTIVE TRANSIENT THERMAL IMPEDANCE, JUNCTION-TO-CASE vs PULSE DURATION

Typical Performance Curves

APT5017BVFR_SVFR

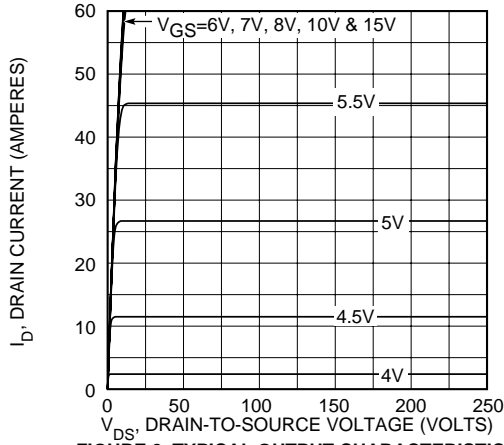


FIGURE 2, TYPICAL OUTPUT CHARACTERISTICS

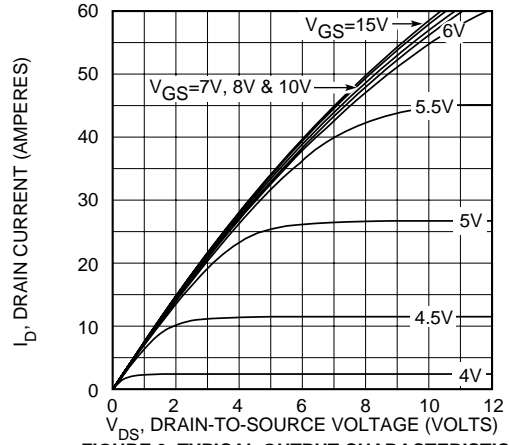


FIGURE 3, TYPICAL OUTPUT CHARACTERISTICS

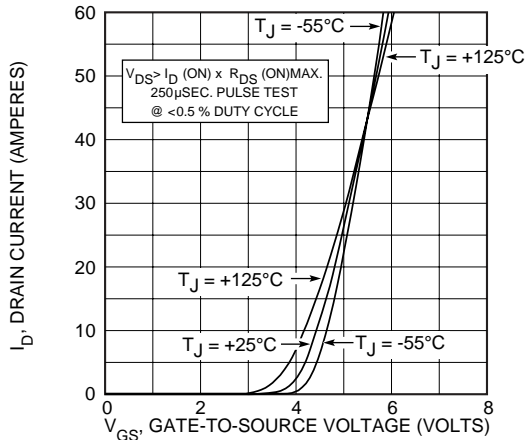


FIGURE 4, TYPICAL TRANSFER CHARACTERISTICS

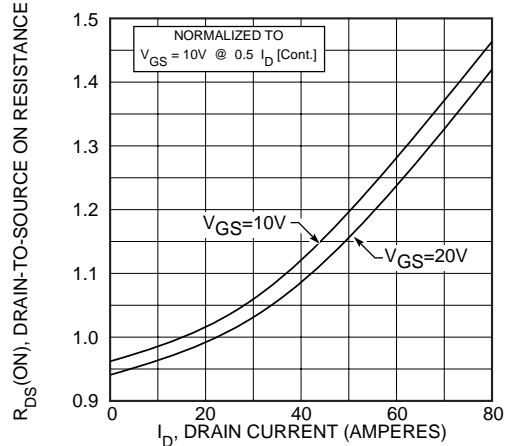


FIGURE 5, $R_{DS(ON)}$ vs DRAIN CURRENT

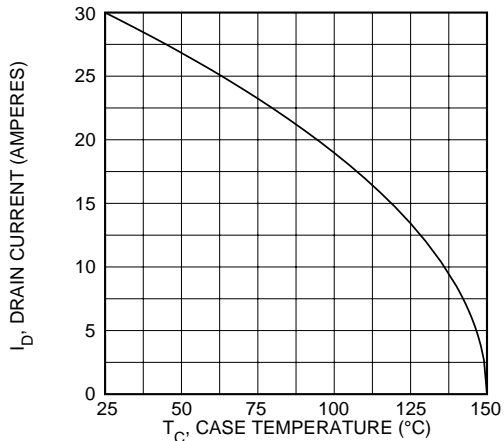


FIGURE 6, MAXIMUM DRAIN CURRENT vs CASE TEMPERATURE

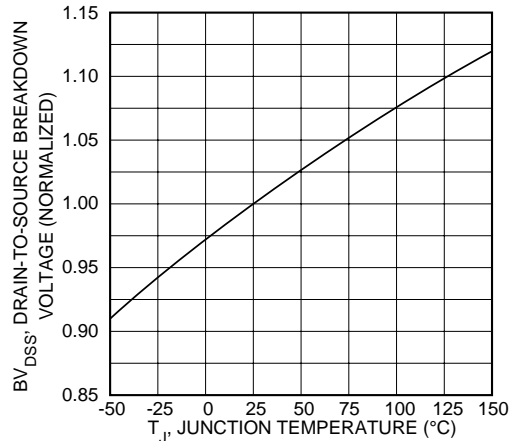


FIGURE 7, BREAKDOWN VOLTAGE vs TEMPERATURE

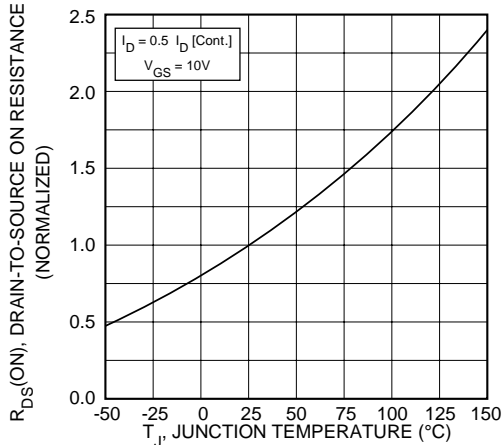


FIGURE 8, ON-RESISTANCE vs. TEMPERATURE

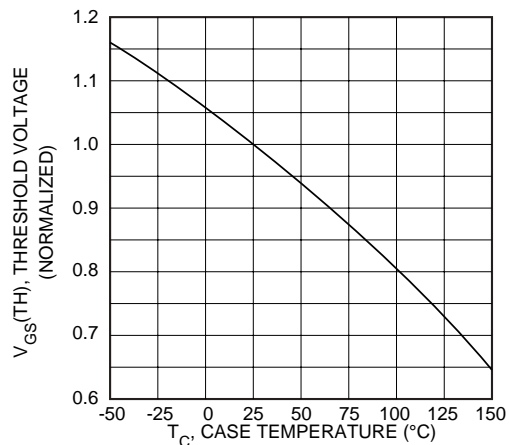


FIGURE 9, THRESHOLD VOLTAGE vs TEMPERATURE

Typical Performance Curves

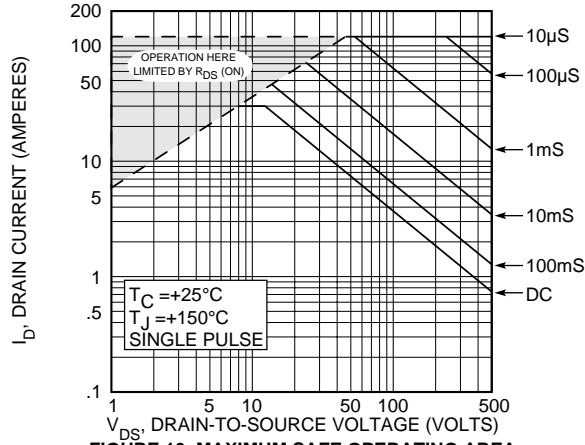


FIGURE 10, MAXIMUM SAFE OPERATING AREA

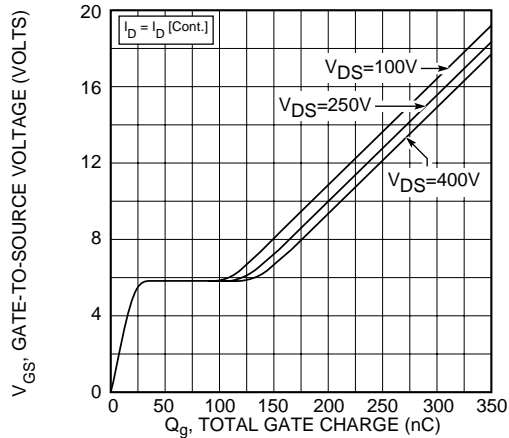


FIGURE 12, GATE CHARGES vs GATE-TO-SOURCE VOLTAGE

APT5017BVFR_SVFR

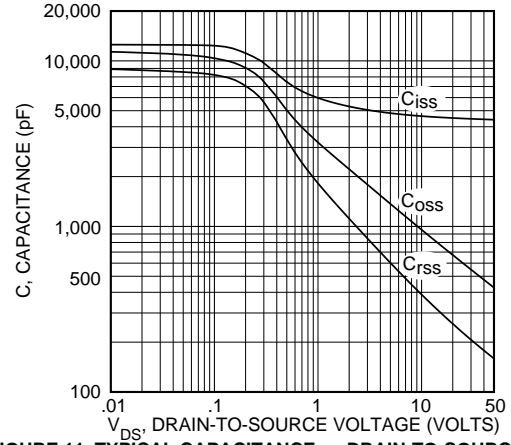


FIGURE 11, TYPICAL CAPACITANCE vs DRAIN-TO-SOURCE VOLTAGE

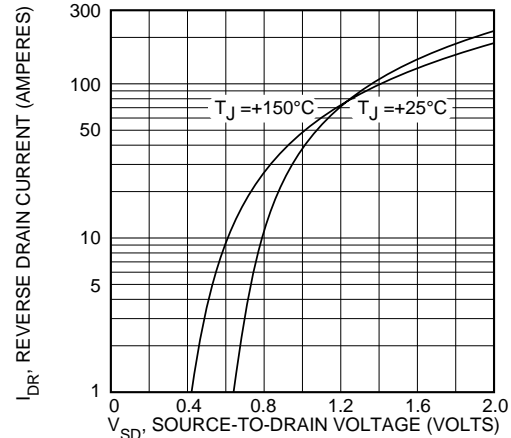
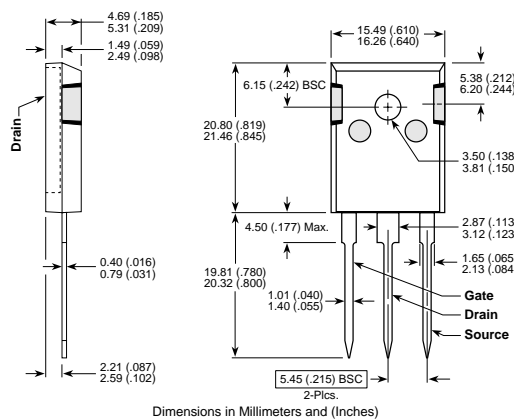


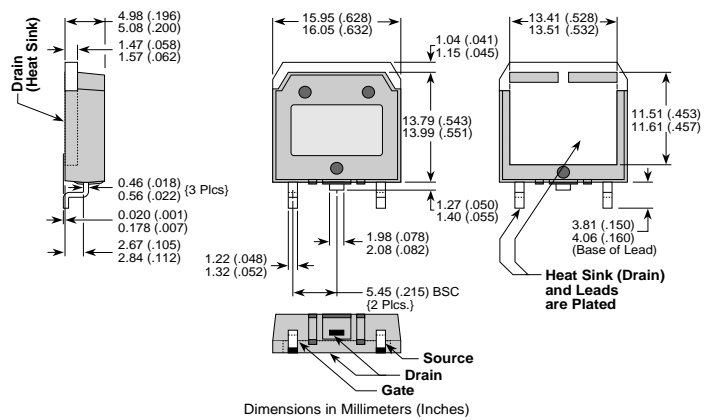
FIGURE 13, TYPICAL SOURCE-DRAIN DIODE FORWARD VOLTAGE

TO-247 Package Outline



Dimensions in Millimeters and (Inches)

D³PAK Package Outline



Dimensions in Millimeters (Inches)

APT's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522

5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. US and Foreign patents pending. All Rights Reserved.